

MOSFET

OptiMOS[™]3 Power-Transistor, 100 V

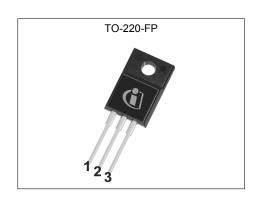
Features

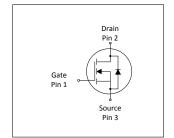
- N-channel, normal level

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 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 175 °C operating temperature
 Pb-free lead plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target application
 Ideal for high-frequency switching and synchronous rectification
 Halogen-free according to IEC61249-2-21



- dio					
Parameter	Value	Unit			
$V_{ m DS}$	100	V			
$R_{DS(on),max}$	4.5	mΩ			
I_{D}	64	A			











Type / Ordering Code	Package	Marking	Related Links
IPA045N10N3 G	PG-TO220-FP	045N10N	-

OptiMOS[™]3 Power-Transistor, 100 V



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OptiMOS[™]3 Power-Transistor, 100 V . IPA045N10N3 G



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Banamatan	Ols al		Values			Note / Took Onwellthen	
Parameter	Symbol	Min.	Min. Typ. N		Unit	Note / Test Condition	
Continuous drain current	I _D	-	-	64 45	А	T _C =25 °C ¹⁾ T _C =100 °C	
Pulsed drain current ¹⁾	I _{D,pulse}	-	-	256	Α	T _C =25 °C	
Avalanche energy, single pulse	E AS	-	-	540	mJ	$I_{\rm D}$ =64 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	39	W	T _C =25 °C	
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56	

Thermal characteristics 2

Thermal characteristics Table 3

Dovomotor	Cymbal	Values			l lmi4	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction-case	R _{thJC}	-	-	3.8	K/W	-	
Thermal resistance, juntion-ambient, Leaded	R _{thJA}	-	-	80	K/W	-	

3 **Electrical characteristics**

Static characteristics Table 4

Parameter	Cumbal	Values			Unit	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	100	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2	2.7	3.5	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 150 \ \mu {\rm A}$	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	3.9 4.7	4.5 7.7	mΩ	V _{GS} =10 V, I _D =64 A V _{GS} =6 V, I _D =32 A	
Gate resistance	R _G	-	1.4	-	Ω	-	
Transconductance	g fs	60	119	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 64 A$	

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 Table 5
 Dynamic characteristics

Davamatav	Cumbal	Values			11!4	Nata / Taat Canditian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	Ciss	-	6320	8410	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz	
Output capacitance	Coss	-	1100	1460	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz	
Reverse transfer capacitance	Crss	-	41	-	pF	V _{GS} =0 V, V _{DS} =50 V, f=1 MHz	
Turn-on delay time	$t_{ m d(on)}$	-	25	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =64 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	-	47	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =64 A, $R_{\rm G,ext}$ =1.6 Ω	
Turn-off delay time	$t_{ m d(off)}$	-	50	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =64 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t _f	-	15	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =64 A, $R_{\rm G,ext}$ =1.6 Ω	

Table 6 Gate charge characteristics¹⁾

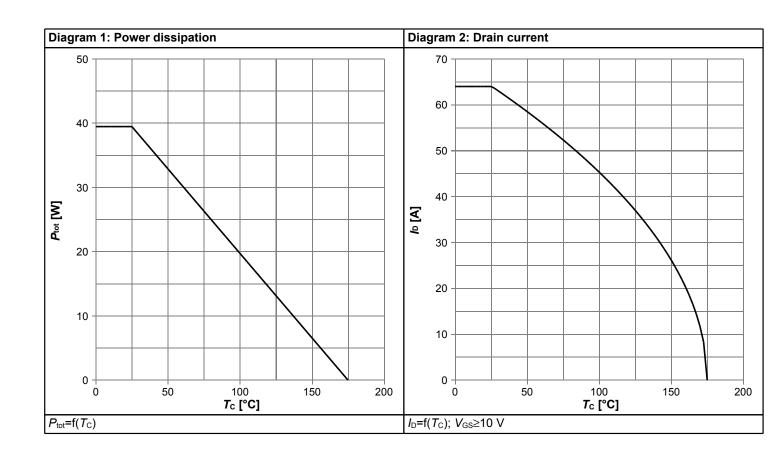
Developer	Comple ed	Values			11:4	Nata / Tank Canadikian	
Parameter	Symbol Min. Typ.		Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q _{gs}	-	28	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =64 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge	Q_{gd}	-	16	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =64 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q _{sw}	-	25	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =64 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total	Qg	-	88	117	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =64 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	V _{plateau}	-	4.4	-	V	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =64 A, $V_{\rm GS}$ =0 to 10 V	
Output charge	Qoss	-	117	155	nC	V _{DD} =50 V, V _{GS} =0 V	

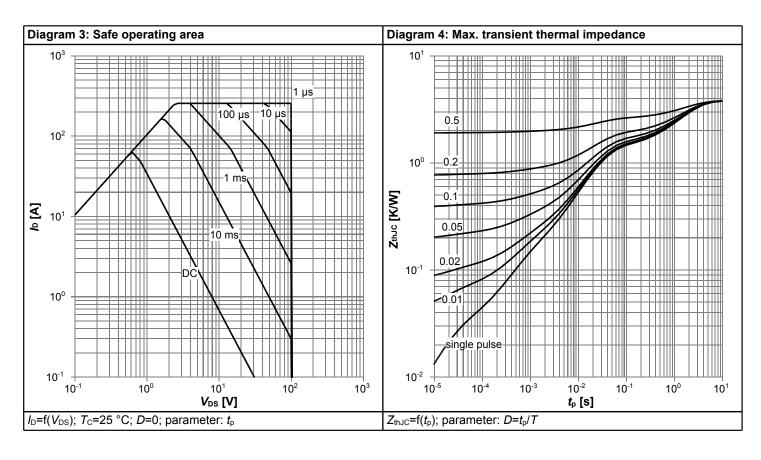
Table 7 Reverse diode

Parameter	Symbol		Values			Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continous forward current	Is	-	-	64	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	256	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.9	1	V	V _{GS} =0 V, I _F =64 A, T _j =25 °C	
Reverse recovery time	t _{rr}	-	69	-	ns	V _R =50 V, I _F =64 A, d <i>i</i> _F /d <i>t</i> =100 A/μs	
Reverse recovery charge	Qrr	-	140	-	nC	V_R =50 V, I_F =64 A, di_F/dt =100 A/ μ s	

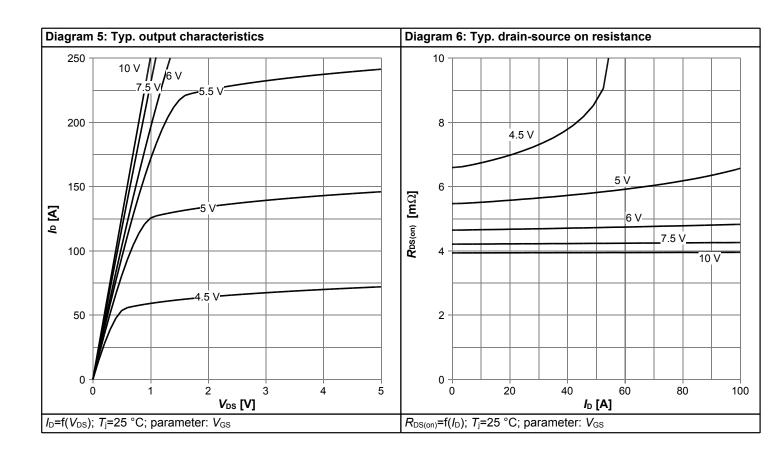


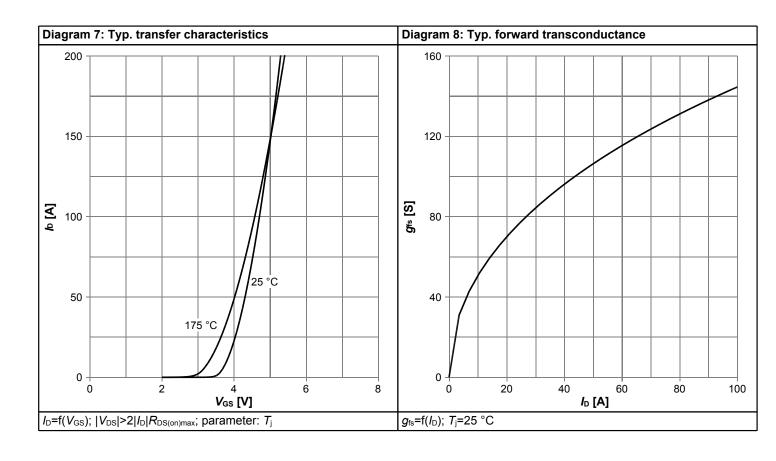
4 Electrical characteristics diagrams



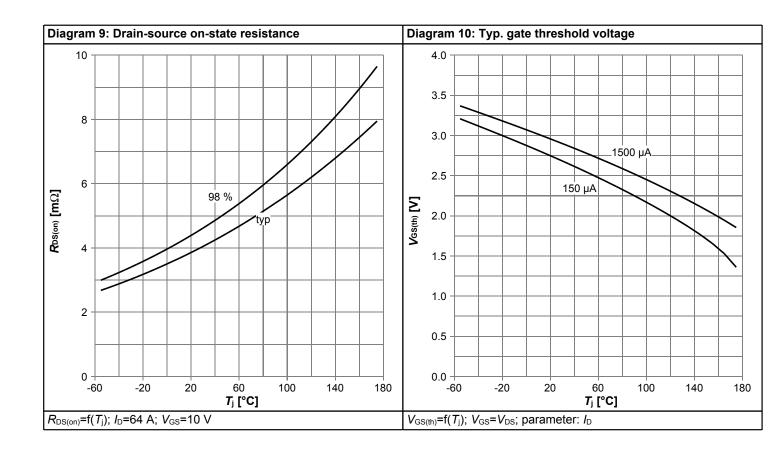


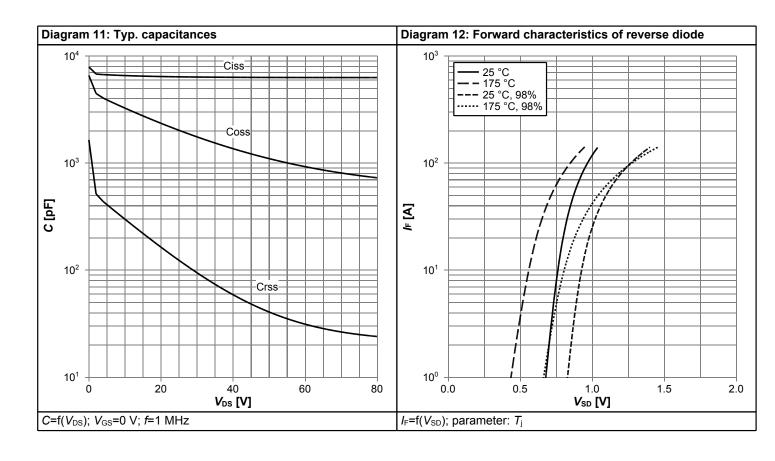




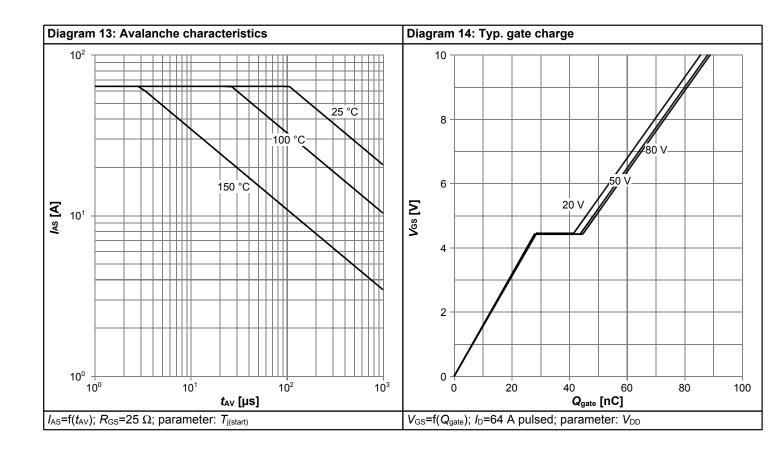


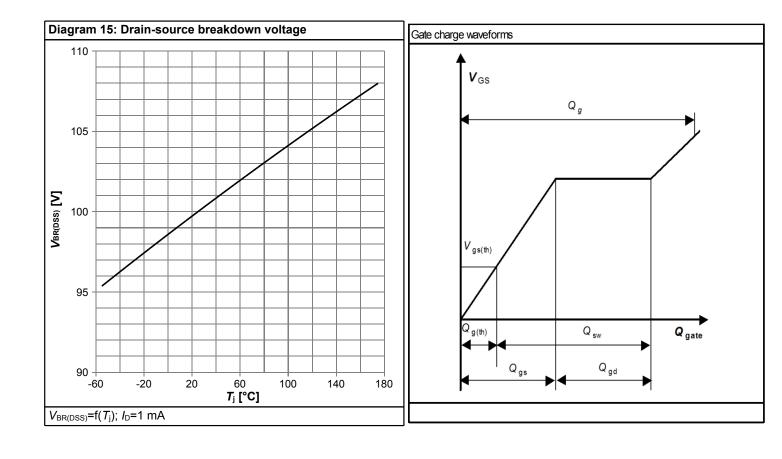






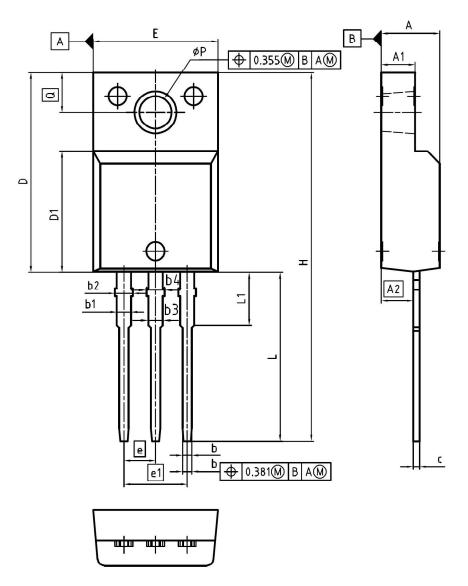








5 Package Outlines



DIM	MILLIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	4.55	4.85	0.179	0.191	
A1	2.55	2.85	0.100	0.112	
A2	2.42	2.72	0.095	0.107	
Ь	0.65	0.85	0.026	0.033	
ь1	0.95	1.33	0.037	0.052	
b2	0.95	1.51	0.037	0.059	
b3	0.65	1.33	0.026	0.052	
b4	0.65	1.51	0.026	0.059	
С	0.40	0.63	0.016	0.025	
D	15.85	16.15	0.624	0.636	
D1	9.53	9.83	0.375	0.387	
E	10.35	10.65	0.407	0.419	
е	2.5	54	0.100		
e1	5.0)8	0.2	200	
N	;	3	;	3	
Н	29.45	29.75	1.159	1.171	
L	13.45	13.75	0.530	0.541	
L1	3.15	3.45	0.124	0.136	
øΡ	2.95	3.20	0.116	0.126	
Q	3.15	3.50	0.124	0.138	

DOCUMENT NO.
Z8B00003319

SCALE

0
2.5
0
2.5
5mm

EUROPEAN PROJECTION

ISSUE DATE
08-03-2007

REVISION
03

Figure 1 Outline PG-TO220-FP, dimensions in mm/inches

OptiMOS[™]3 Power-Transistor, 100 V IPA045N10N3 G



Revision History

IPA045N10N3 G

Revision: 2016-01-22, Rev. 2.4

Drovious	Revision
Previous	Revision

Revision	Date	Subjects (major changes since last revision)
2.4	2016-01-22	Insert RthJA

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